FTB-810 NetBlazer Series Transport Tester

COMPLETE, FAST, INTUITIVE TRANSPORT TESTING



Comprehensive, yet simple test suites for field technicians to easily turn up, validate and troubleshoot transport circuits covering all DSn/PDH and SONET/SDH interfaces up to 10 Gbit/s.

KEY FEATURES AND BENEFITS

Complete test suite for DSn/PDH and SONET/SDH interfaces up to 10 Ghit/s

Simplified BER testing with pass/fail indicators based on userdefined thresholds

Unprecedented configuration simplicity with hybrid touchscreen/keypad navigation and data entry

No data interpretation errors with revolutionary new GUI on 7-inch TFT screen, historical event logger, visual gauges and 3D-icon depictions of pass/fail outcomes

Simpler reporting with integrated Wi-Fi and Bluetooth connectivity capabilities

Centralized support for injection/monitoring of errors and alarms, trace messaging, overhead monitoring/manipulation and performance monitoring statistics

Extended field autonomy with compact, lightweight platform equipped with a long-duration battery pack

PLATFORM COMPATIBILITY



Platform FTB-1

THE ULTRA-PORTABLE CHOICE FOR DSN/PDH AND SONET/SDH TESTING

With a large installed base, testing DSn/PDH and SONET/SDH circuits, both in access and metro networks, continues to be a daily need that requires a test unit that is comprehensive, without sacrificing portability, speed or cost. Leveraging the powerful, intelligent FTB-1 handheld platform, the FTB-810 NetBlazer series streamlines processes and empowers field technicians to test and validate DSn/PDH and SONET/SDH circuits efficiently.

Powerful and Fast

Available in two hardware models (FTB-810 and FTB-810G), the FTB-810 NetBlazer series delivers fully integrated DSn/PDH and SONET/SDH testing and offers the industry's largest touch screen with unprecedented configuration simplicity via hybrid touchscreen/keypad navigation. Platform connectivity is abundant via Wi-Fi, Bluetooth, Gigabit Ethernet or USB ports, making it accessible in any environment.

The Testing You Need for Any DSn/PDH or SONET/SDH Application

- > Installation, commissioning and maintenance of access and metro networks
- > Turn-up of DSn/PDH or SONET/SDH circuits
- > Performance assessment and troubleshooting
- > Performance monitoring of DSn/PDH and SONET/SDH circuits
- > Round-trip delay assessment of transport circuits
- > BER testing up to OC-192/STM-64

FTB-810G: DSN/PDH AND SONET/SDH UP TO 10 GBIT/S

If the need is for transport testing at all rates up to 10 Gbit/s, then the FTB-810G is the perfect solution.

- > SFP port for OC-3/12/48 or STM-1/4/16
- > SFP+ port for OC-192 or STM-64
- > RJ-48C and bantam ports for DS1 or E1
- > BNC port for DS3, E1/E3/E4, STS-1e/STS-3e or STM-0e/STM-1e

- > DS1/DS3 and E1/E3/E4 testing
- OC-3/12/48/192 and STM-1/4/16/64 BER testing with configurable threshold settings
- > Coupled, Decoupled and Through mode testing
- > Error and alarm insertion and monitoring
- > Overhead monitoring and manipulation
- > High-order and low-order mappings
- > Tandem connection monitoring (TCM)
- Pointer manipulation, including pointer sequence testing as per Telcordia GR-253, ANSI T1.105-03 and ITU G.783
- Performance monitoring as per G.821, G.826, G.828, G.829, M.2100, M.2101

- > Frequency analysis and offset generation
- > Automatic protection switching
- > Service-disruption time measurements
- > Round-trip delay measurements
- > Dual DS1/DS3 receiver (Rx) support
- > DS1 loop codes and NI/CSU emulation
- DS1/DS3 autodetection of line code, framing and pattern
- > DS1 FDL and DS3 FEAC
- > Fractional T1/E1 testing
- > External clock sync support

FTB-810: DSN/PDH AND SONET/SDH UP TO 2.5 GBIT/S

If the need is only for transport testing at all rates up to 2.5 Gbit/s, then the FTB-810 is the answer.

- > SFP port for OC-3/12/48 or STM-1/4/16
- > RJ-48C and bantam ports for DS1 or E1
- BNC port for DS3, E1/E3/E4, STS-1e/STS-3e or STM-0e/STM-1e
- > DS1/DS3 and E1/E3/E4 testing
- OC-3/12/48 and STM-1/4/16 BER testing with configurable threshold settings
- > Coupled, Decoupled and Through mode testing
- > Error and alarm insertion and monitoring
- > Overhead monitoring and manipulation
- > High-order and low-order mappings
- > Tandem connection monitoring (TCM)
- Pointer manipulation, including pointer sequence testing as per Telcordia GR-253, ANSI T1.105-03 and ITU G.783
- Performance monitoring as per G.821, G.826, G.828, G.829, M.2100, M.2101

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- > External clock sync support

Setting a New GUI Standard: Unprecedented Simplicity in Configuration Setup and Navigation

The FTB-810 NetBlazer's intelligent situational configuration setup feature guides technicians through complete, accurate testing processes (suggestion prompts, help guides, etc.). It reduces navigation by combining associated testing functions on a single screen.

Dedicated Quick-Action Buttons

- > Laser on/off
- > Test reset to clear the results and statistics while running a test
- > Report generation
- > Save or load test configurations
- > Quick error injection

Streamlined Navigation

- > Testing status can be maximized to fill the entire screen by simply clicking on the Alarm Status button; whether the unit is in your hand or across the room, test results can easily be determined with a simple glance at the display screen
- Simplified test structure definition using task-based test application selection, signal configuration front end and smart timeslot selection
- Centralized functions: error/alarm management, performance monitoring and overhead manipulation/monitoring

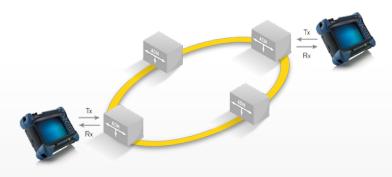
Assorted Notifications

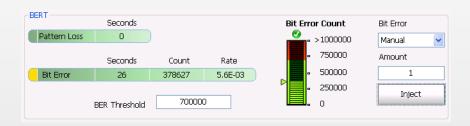
- > Optical power status available at all times
- > Pass/fail indication at all times
- > Pattern and clock synchronization
- > Electrical/optical power monitoring with valid-range color indicator (optical interface)
- > Frequency offset with valid-range color indicator
- > Overhead overwrite indicator
- > Error/alarm injection
- > Alarm hierarchy pinpointing the root-cause (when possible)

Key Features

Simplified BER Testing

The FTB-810 NetBlazer series provides the ability to pre-configure bit-error-rate (BER) thresholds that are user-defined prior to running the test. This allows for a simple pass/fail verdict at the conclusion of the test, leaving no room for misinterpretation of the test results.





Decoupled Mode

The Decoupled mode enables the user to independently configure the Tx and Rx ports of the FTB-810 NetBlazer module. This is required for testing the mapping and demapping functionality of a network element or at cross-connect points in the network.



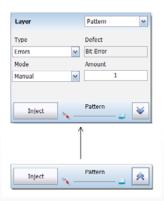
Through Mode

This mode is required for in-service monitoring of the network. The FTB-810 NetBlazer can be inserted in-line on a specific link, and can then monitor and analyze the errors and alarms on that link while remaining non-intrusive.



Simplified Error Injection

This FTB-810 feature enables the user to inject errors with a single click, from any screen. This allows technicians to ensure circuit continuity prior to starting a test. Furthermore, the error injection functionality can be pre-programmed for any given type of error, and not just for bit errors.





Complete Overhead Monitoring

The FTB-810 NetBlazer offers access to the entire SONET/SDH overhead (OH) bytes from a single page. Furthermore, by selecting any given OH byte, the user can retrieve additional detailed information about that byte without having to switch pages.



SPECIFICATIONS

SFP OPTICAL INTERFACES												
	OC-3/STM-1			OC-12/STM-4			OC-48/STM-16					
Reach and wavelength	15 km; 1310 nm	40 km; 1310 nm	40 km; 1550 nm	80 km; 1550 nm	15 km; 1310 nm	40 km; 1310 nm	40 km; 1550 nm	80 km; 1550 nm	15 km; 1310 nm	40 km; 1310 nm	40 km; 1550 nm	80 km; 1550 nm
Tx level (dBm)	-5 to 0	-2 to 3	-5 to 0	-2 to 3	-5 to 0	-2 to 3	-5 to 0	-2 to 3	-5 to 0	-2 to 3	-5 to 0	-2 to 3
Rx operating range (dBm)	-23 to -10	−30 to −15	-23 to -10	−30 to −15	-22 to 0	−27 to −9	-22 to 0	-29 to -9	-18 to 0	-27 to -9	-18 to 0	-28 to -9
Transmit bit rate		155.52 Mbit	/s ±4.6 ppm			622.08 Mbit	/s ±4.6 ppm			2.48832 Gb	it/s ±4.6 ppm	
Frequency offset generation (ppm)	±50				±ŧ	50		±50				
Receive bit rate	155.52 Mbit/s ±100 ppm			622.08 Mbit/s ±100 ppm			2.48832 Gbit/s ±100 ppm					
Operational wavelength range	1261 to 1360 nm	1263 to 1360 nm	1430 to 1580 nm	1480 to 1580 nm	1270 to 1360 nm	1280 to 1335 nm	1430 to 1580 nm	1480 to 1580 nm	1260 to 1360 nm	1280 to 1335 nm	1430 to 1580 nm	1500 to 1580 nm
Spectral width		1 nm (-	-20 dB)		1 nm (-20 dB)		1 nm (-20 dB)					
Measurement accuracy (uncertainty) Frequency (ppm) Optical power (dB)	±4.6 ±2			±4.6 ±2			±4.6 ±2					
Maximum Rx before damage (dBm) a	3			3			3					
Jitter compliance	GR-253 (SONET) G.958 (SDH)			GR-253 (SONET) G.958 (SDH)		GR-253 (SONET) G.958 (SDH)						
Line coding	NRZ			NRZ		NRZ						
Eye safety	Class 1			Class 1		Class 1						
Connector ^b	Dual LC			Dual LC		Dual LC						
Transceiver type °	SFP			SFP		SFP						

SFP+ OPTICAL INTERFACES						
	OC-192/STM-64	OC-192/STM-64	OC-192/STM-64			
Wavelength (nm)	1310	1550	1550			
Tx level (dBm)	−6 to −1	-1 to 2	0 to 4			
Rx level sensitivity (dBm)	-11 to 0.5	−14 to −1	−24 to −7			
Maximum reach	10 km	40 km	80 km			
Transmission bit rate (Gbit/s)	9.95328 ±4.6 ppm	9.95328 ±4.6 ppm	9.95328 ±4.6 ppm			
Frequency offset generation (ppm)	±50	±50	±50			
Reception bit rate (Gbit/s)	9.95328 ±100 ppm	9.95328 ±100 ppm	9.95328 ±100 ppm			
Tx operational wavelength range (nm)	1260 to 1355	1530 to 1565	1530 to 1565			
Measurement accuracy (uncertainty) Frequency (ppm) Optical power (dB)	±4.6 ±2	±4.6 ±2	±4.6 ±2			
Maximum Rx before damage (dBm) ^a	5	5	3			
Jitter compliance	GR-253 (SONET) G.825 (SDH)	GR-253 (SONET) G.825 (SDH)	GR-253 (SONET) G.825 (SDH)			
Eye safety	Class 1	Class 1	Class 1			
Connector ^b	LC	LC	LC			
Transceiver type ^d	SFP+	SFP+	SFP+			

Notes

- a. In order not to exceed the maximum receiver power level before damage, an attenuator must be used.
- b. External adaptors can be used for other types of connectors.
- c. SFP compliance: The FTB-810 selected SFP shall meet the requirements stated in the "Small Form-Factor Pluggable (SFP) Transceiver Multisource Agreement (MSA)". The FTB-810 selected SFP shall meet the requirements stated in the "Specification for Diagnostic Monitoring Interface for Optical Xcvrs".
- d. SFP+ compliance: The FTB-810 selected SFP+ shall meet the requirements stated in the SFP-8431 "Enhanced Small Form-Factor Pluggable Module SFP+" Transceiver Multisource Agreement (MSA)". The FTB-810 selected SFP+ shall meet the requirements stated in the "Specification for Diagnostic Monitoring Interface for Optical Xcvrs".

DSN/PDH AND SONET/SDH ELECTRICAL INTERFACES									
	DS1	E1/	2M	E3/34M	DS3/	/45M	STS-1e/STM-0e/52M	E4/140M	STS-3e/STM-1e/155M
Tx pulse amplitude	2.4 to 3.6 V	3.0 V	2.37 V	1.0 ±0.1 V	0.36 to	0.85 V		1.0 ±0.1 Vpp	0.5 V
Tx pulse mask	GR-499 Figure 9.5	G.703 Figure 15	G.703 Figure 15	G.703 Figure 17	DS-3 GR-499 Figure 9-8	45M G.703 Figure 14	GR-253 Figure 4-10/4-11	G.703 Figure 18/19	STS-3e GR-253 G.703 Figure 4-12, 4-13, 4-14 and 23
Tx LBO preamplification	0-133 ft 133-266 ft 266-399 ft 399-533 ft 533-655 ft				0 to 2 225 to		0 to 225 ft 225 to 450 ft		0 to 225 ft
Cable simulation	-22.5 dB -15.0 dB -7.5 dB 0 dB				450 to 90	00 (927) ft	450 to 900 (927) ft		
Rx level sensitivity	For 772 kHz: TERM: ≤ 26 dB (cable loss only) at 0 dBdsx Tx DSX-MON: ≤ 26 dB (20 dB resistive loss + cable loss ≤ 6 dB) Bridge: ≤ 6 dB (cable loss only)	For 1024 kHz: TERM: ≤ 6 dB (cable loss only) MON: ≤ 26 dB (20 dB resistive loss + cable loss ≤ 6 dB) Bridge: ≤ 6 dB (cable loss only)	For 1024 kHz: TERM: ≤ 6 dB (cable loss only) MON: ≤ 26 dB (20 dB resistive loss + cable loss ≤ 6 dB) Bridge: ≤ 6 dB (cable loss only)	For 17.184 MHz: TERM: ≤ 12 dB (coaxial cable loss only) MON: ≤ 26 dB (20 dB resistive loss + cable loss ≤ 8 dB)	DSX-MON:	≤ 10 dB oss only) : ≤ 26.5 dB sistive loss +	For 25.92 MHz: TERM: ≤ 10 dB (cable loss only) MON: ≤ 25 dB (20 dB resistive loss + cable loss ≤ 5 dB)	For 70 MHz: TERM: ≤ 12 dB (coaxial cable loss only) MON: ≤ 26 dB (20 dB resistive loss + cable loss ≤ 6 dB)	For 78 MHz: TERM: ≤ 12.7 dB (coaxial cable loss only) MON: ≤ 26 dB (20 dB resistive loss + cable loss ≤ 6 dB)
Transmit bit rate	1.544 Mbit/s ±4.6 ppm	2.048 Mbit/s ±4.6 ppm	2.048 Mbit/s ±4.6 ppm	34.368 Mbit/s ±4.6 ppm	44.736 ±4.6	Mbit/s ppm	51.84 Mbit/s ±4.6 ppm	139.264 Mbit/s ±4.6 ppm	155.52 Mbit/s ±4.6 ppm
Frequency offset generation	1.544 Mbit/s ±140 ppm	2.048 Mbit/s ±70 ppm	2.048 Mbit/s ±70 ppm	34.368 Mbit/s ±50 ppm		Mbit/s ppm	51.84 Mbit/s ±50 ppm	139.264 Mbit/s ±50 ppm	155.52 Mbit/s ±50 ppm
Receive bit rate	1.544 Mbit/s ±140 ppm	2.048 Mbit/s ±100 ppm	2.048 Mbit/s ±100 ppm	34.368 Mbit/s ±100 ppm	44.736 ±100		51.84 Mbit/s ±100 ppm	139.264 Mbit/s ±100 ppm	155.52 Mbit/s ±100 ppm
Measurement accuracy (uncertainty) Frequency (ppm) Electrical power (dB)	±4.6 ±1.5	±4.6 ±1.5	±4.6 ±1.5	±4.6 ±1.5	±4 ±1		±4.6 ±1.5	±4.6 ±1.5	±4.6 ±1.5
Peak-to-peak voltage	±10 % down to 500 mVpp	±10 % down to 500 mVpp	±10 % down to 500 mVpp	±10 % down to 500 mVpp	±10 % 200 r	down to nVpp	±10 % down to 200 mVpp	±10 % down to 200 mVpp	±10 % down to 200 mVpp
Intrinsic jitter (Tx)	ANSI T1.403 section 6.3 GR-499 section 7.3	G.823 section 5.1	G.823 section 5.1	G.823 section 5.1 G.751 section 2.3	GR-449 s (categorie		GR-253 section 5.6.2.2 (category II)	G.823 section 5.1	G.825 section 5.1 GR-253 section 5.6.2.2
Input jitter tolerance	AT&T PUB 62411 GR-499 section 7.3	G.823 section 7.1	G.823 section 7.1	G.823 section 7.1	GR-449 s (categorie	ection 7.3 es I and II)	GR-253 section 5.6.2.2 (category II)	G.823 section 7.1 G.751 section 3.3	G.825 section 5.2 GR-253 section 5.6.2.3
Line coding	AMI and B8ZS	AMI and HDB3	AMI and HDB3	HDB3	Вз	ZS	B3ZS	СМІ	CMI
Input impedance (resistive termination)	100 ohms ±5 %, balanced	120 ohms ±5 %, balanced	75 ohms ±5 %, unbalanced	75 ohms ±5 %, unbalanced	75 ohm unbala		75 ohms ±5 %, unbalanced	75 ohms ±10 %, unbalanced	75 ohms ±5 %, unbalanced
Connector type	BANTAM and RJ-48C	BANTAM and RJ-48C	BNC	BNC	ВМ	NC	BNC	BNC	BNC

SYNCHRONIZATION INTERFACES						
	External Clock DS1/1.5M	External Clock E1/2M	External Clock E1/2M	Trigger 2 MHz		
Tx pulse amplitude	2.4 to 3.6 V	3.0 V	2.37 V	0.75 to 1.5 V		
Tx pulse mask	GR-499 figure 9.5	G.703 figure 15	G.703 figure 15	G.703 figure 20		
Tx LBO preamplification	Typical power dBdsx +0.6 dBdsx (0-133 ft) +1.2 dBdsx (133-266 ft) +1.8 dBdsx (266-399 ft) +2.4 dBdsx (399-533 ft) +3.0 dBdsx (533-655 ft)					
Rx level sensitivity	TERM: ≤ 6 dB (cable loss only) (at 772 kHz for T1) DSX-MON: ≤ 26 dB (20 dB resistive loss + cable loss ≤ 6 dB) Bridge: ≤ 6 dB (cable loss only)	TERM: ≤ 6 dB (cable loss only) MON: ≤ 26 dB (20 dB resistive loss + cable loss ≤ 6 dB) Bridge: ≤ 6 dB (cable loss only)	TERM: ≤ 6 dB (cable loss only) MON: ≤ 26 dB (resistive loss + cable loss ≤ 6 dB) Bridge: ≤ 6 dB (cable loss only)	≤ 6 dB (cable loss only)		
Transmission bit rate	1.544 Mbit/s ± 4.6 ppm	2.048 Mbit/s ± 4.6 ppm	2.048 Mbit/s ± 4.6 ppm			
Reception bit rate	1.544 Mbit/s ± 50 ppm	2.048 Mbit/s ± 50 ppm	2.048 Mbit/s ± 50 ppm			
Intrinsic jitter (Tx)	ANSI T1.403 section 6.3 GR-499 section 7.3	G.823 section 6.1	G.823 section 6.1	G.703 table 11		
Input jitter tolerance	AT&T PUB 62411 GR-499 section 7.3	G.823 section 7.2 G.813	G.823 section 7.2 G.813			
Line coding	AMI and B8ZS	AMI and HDB3	AMI and HDB3	G.823 section 7.1 G.751 section 3.3		
Input impedance (resistive termination)	75 ohms ± 5 %, unbalanced	75 ohms ± 5 %, unbalanced	75 ohms ± 5 %, unbalanced	75 ohms ± 5 %, unbalanced		
Connector type	BNC a	BNC ^a	BNC	BNC		

Note

a. Adaptation cable required for BANTAM.

FUNCTIONAL SONET AND DS	N SI ECIFICATIONS	FUNCTIONAL SDH AND PDH	SECULICATIONS
Optical interfaces	OC-3, OC-12, OC-48, OC-192	Optical interfaces	STM-1, STM-4, STM-16, STM-64
Available wavelengths (nm)	1310, 1550	Available wavelengths (nm)	1310, 1550
Electrical interfaces	DS1, DS3, STS-1e, STS-3e	Electrical interfaces ^a	1.5M (DS1), 2M (E1), 34M (E3), 45M (DS3), 140M (E4 STM-0e, STM-1e
DS1 framing	Unframed, SF, ESF, SLC-96	2M (E1) framing	Unframed, PCM30, PCM31, PCM30 CRC-4, PCM31 CR
DS3 framing	Unframed, M13, C-bit parity	8M (E2), 34M (E3), 140M (E4) framing	Unframed (not applicable to E2), framed
Clocking	Internal, loop-timed, external (BITS)	Clocking	Internal, loop-timed, external (MTS/SETS), 2 MHz
Mappings			
VT1.5	Bulk, DS1	AU-3-TU-11, AU-4-TU-11	Bulk, 1.5M,
VT2	Bulk, E1	AU-3 -TU-12, AU-4-TU-12	Bulk, 1.5M, 2M
STS-1 SPE	Bulk, DS3	AU-3-Bulk, 34M, 45M, TU-3-AU-4	Bulk, 34M, 45M
STS-3c	Bulk	AU-4	Bulk, 140M
STS-12c/48c/192c, SPE	Bulk	AU-4-4c/16c/64c	Bulk
SONET overhead analysis and manipulation	A1, A2, J0, E1, F1, D1-D12, K1, K2, S1, M0, M1, E2, J1, C2, G1, F2, H4, Z3, Z4, Z5, N1, N2, Z6, Z7	SDH overhead analysis and manipulation	A1, A2, J0, E1, F1, D1-D12, K1, K2, S1, M0, M1 G1, F2, F3, K3, N1, N2, K4, E2, J1, C2, H4
Error incortion	J1, G2, G1, F2, F14, Z3, Z4, Z3, N1, N2, Z6, Z7		G1, F2, F3, N3, N1, N2, N4, E2, J1, C2, H4
Error insertion	Examine hit PDV CDC 6 hit EV7	E1 (OM)	Dit ower EAS OV ODG 4 F Lit
DS1	Framing bit, BPV, CRC-6, bit error, EXZ	E1 (2M)	Bit error, FAS, CV, CRC-4, E-bit
DS3	BPV, C-bit, F-bit, P-bit, FEBE, bit error, EXZ	E2 (8M), E3 (34M), E4 (140M)	Bit error, FAS, CV (not applicable to E2)
STS-1e, STS-3e	Section BIP (B1), line BIP (B2), path BIP (B3), BIP-2, REI-L, REI-P, REI-V, BPV, FAS, CV, bit error	STM-0e, STM-1e	RS-BIP (B1), MS-BIP (B2), HP-BIP (B3), MS-REI, HP-REI, LP-BIP-2, LP-REI, CV, FAS, bit error
OC-3, OC-12, OC-48, OC-192	Section BIP (B1), line BIP (B2), path BIP (B3), BIP-2, REI-L, REI-P, REI-V, FAS, bit error	STM-1, STM-4, STM-16, STM-64	RS-BIP (B1), MS-BIP (B2), HP-BIP (B3), MS-REI, HP-REI, LP-BIP-2, LP-REI, FAS, bit error
Error measurement			
DS1	Framing bit, BPV, CRC-6, EXZ, bit error	E1 (2M)	Bit error, FAS, CV, CRC-4, E-bit
DS3	BPV, C-bit, F-bit, P-bit, FEBE, bit error, EXZ	E2 (8M), E3 (34M), E4 (140M)	Bit error, FAS, CV (not applicable to E2)
STS-1e, STS-3e	Section BIP (B1), line BIP (B2), path BIP (B3), BIP-2, REI-L, REI-P, REI-V, BPV, FAS, CV, bit error	STM-0e, STM-1e	RS-BIP (B1), MS-BIP (B2), HP-BIP (B3), MS-REI, HP-REI, LP-BIP-2, LP-REI, CV, FAS, bit error
OC-3, OC-12, OC-48, OC-192	Section BIP (B1), line BIP (B2), path BIP (B3), BIP-2, REI-L, REI-P, REI-V, FAS, bit error	STM-1, STM-4, STM-16, STM-64	RS-BIP (B1), MS-BIP (B2), HP-BIP (B3), MS-REI, HP-REI, LP-BIP-2, LP-REI, FAS, bit error
Alarm insertion			
DS1	LOS, RAI, AIS, OOF, pattern loss	E1 (2M)	LOS, LOS Mframe, LOF, AIS, TS16 AIS, RAI, RAI Mfran pattern loss
DS3	LOS, RDI, AIS, OOF, DS3 idle, pattern loss	E2 (8M), E3 (34M), E4 (140M)	LOS, LOF, RAI, AIS, pattern loss
STS-1e, STS-3e, OC-3, OC-12, OC-48, OC-192	LOS, LOF-S, SEF, AIS-L, RDI-L, AIS-P, LOP-P, LOM, PDI-P, RDI-P, ERDI-PCD, ERDI-PPD, ERDI-PSD, UNEQ-P, AIS-V, LOP-V, RDI-V, ERDI-VCD, ERDI-VPD, ERDI-VSD, RFI-V, UNEQ-V, pattern loss	STM-0e, STM-1e, STM-1, STM-4, STM-16, STM-64	LOS, LOF, OOF, MS-AIS, MS-RDI, AU-AIS, AU-LOP, H4-LOM, HP-ERDI-CD, HP-ERDI-PD, HP-ERDI-SD, LP-ERDI-CD, LP-ERDI-PD, LP-ERDI-SD, HP-UNEQ, TU- LP-RFI, LP-RDI, LP-RFI, LP-UNEQ, pattern loss
Alarm detection			
DS1	LOS, LOC, RAI, AIS, OOF, pattern loss	E1 (2M)	LOS, LOS Mframe, LOC, LOF, AIS, TS16 AIS, RAI, RA Mframe, pattern loss
DS3	LOS, LOC, RDI, AIS, OOF, DS3 idle, pattern loss	E2 (8M), E3 (34M), E4 (140M)	LOS, LOC, LOF, RAI, AIS, pattern loss
STS-1e, STS-3e, OC-3, OC-12, OC-48, OC-192	LOS, LOC, LOF-S, SEF, TIM-S, AIS-L, RDI-L, AIS-P, LOP-P, LOM, PDI-P, RDI-P, ERDI-PCD, ERDI-PPD, ERDI-PSD, PLM-P, UNEQ-P, TIM-P, AIS-V, LOP-V, RDI-V, ERDI-VCD, ERDI-VPD, ERDI-VSD, RFI-V, UNEQ-V, TIM-V, PLM-V, pattern loss	STM-0e, STM-1e, STM-1, STM-4, STM-16, STM-64	LOS, RS-LOF, LOC, RS-OOF, RS-TIM, MS-AIS, MS-RD AU-AIS, AU-LOP, H4-LOM, HP-RDI, HP-ERDI-CD, HP-ERDI-PD, HP-ERDI-SD, LP-ERDI-CD, LP-ERDI-PD, LP-ERDI-SD, HP-PLM, HP-UNEC, HP-TIM, TU-AIS, LP-F LP-RDI, LP-RFI, LP-UNEC, LP-TIM, LP-PLM, pattern loss
	Frequency alarm on	all supported interfaces	
Patterns			
DS0	2E9-1, 2E11-1, 2E20-1, 1100, 1010, 1111, 0000, 1-in-8, 1-in-16, 3-in-24, 32 bit programmable (inverted or non-inverted), bit errors	E0 (64K)	2E9-1, 2E11-1, 2E20-1, 1100, 1010, 1111, 0000 1-in-8, 1-in-16, 3-in-24, 32 bit programmable (inverted or non-inverted), bit errors
DS1	2E9-1, 2E11-1, 2E15-1, 2E20-1, 2E23-1, 2E31-1, 1100, 1010, 1111, 0000, QRSS, 1-in-8, 1-in-16, 3-in-24, 32 bit programmable (inverted or non-inverted), T1-DALY, 55-octet, bit errors	E1 (2M)	2E9-1, 2E11-1, 2E15-1, 2E20-1, 2E23-1, 2E31-1, 110 1010, 1111, 0000, 1-in-8, 1-in-16, 3-in-24, 32 bit programmable (inverted or non-inverted), bit errors
DS3	2E9-1, 2E11-1, 2E15-1, 2E20-1, 2E23-1, 2E31-1, 1100, 1010, 1111, 0000, 1-in-8, 1-in-16, 3-in-24, 32 bit programmable (inverted or non-inverted), bit errors	E3 (34M), E4 (140M)	2E9-1, 2E11-1, 2E15-1, 2E20-1, 2E23-1, 2E31-1, 110 1010, 1111, 0000, 1-in-8, 1-in-16, 3-in-24°, 32 bit programmable (inverted or non-inverted), bit errors
VT1.5/2	2E9-1, 2E11-1, 2E15-1, 2E20-1, 2E23-1, 2E31-1, 1100, 1010, 1111, 0000, 1-in-8, 1-in-16, 32 bit programmable (inverted or non-inverted), bit errors	TU-11/12/3	2E9-1, 2E11-1, 2E15-1, 2E20-1, 2E23-1, 2E31-1, 110 1010, 1111, 0000, 1-in-8, 1-in-16, 32 bit programmable (inverted or non-inverted), bit errors
STS-1, STS-3c/12c/48c/192c	2E9-1, 2E11-1, 2E15-1, 2E20-1, 2E23-1, 2E31-1, 1100, 1010, 1111, 0000, 1-in-8, 1-in-16, 32 bit programmable (inverted or non-inverted), bit errors	AU-3/AU-4/AU-4-4c/16c/64c	2E9-1, 2E11-1, 2E15-1, 2E20-1, 2E23-1, 2E31-1, 1100, 1010, 1111, 0000, 1-in-8, 1-in-16, 32 bit programmable (inverted or non-inverted), bit error

Notes

- a. 1.5M (DS1) and 45M (DS3) interfaces described under SONET and DSn column.
- b. Not supported for E4 (140M).

DSn/PDH AND SONET/S	DH TEST FEATURES						
Frequency measurements	Supports clock frequency measurements (i.e., received frequency and deviation of the input signal clock from nominal frequency), displayed in ppm, for optical and electrical interfaces. Measurements are performed using a local oscillator.						
Frequency offset generation	Supports offsetting the clock of the transmitted signal on a selected interface to exercise clock recovery circuitry on network elements.						
Dual DSn receivers	Supports two DS1 or DS3 receivers, allowing users to simultaneously monitor two directions of a circuit under test in parallel, resulting in quick isolation of the source of errors.						
Performance monitoring	The following ITU-T recommendations, and corresponding performance monitoring parameters, are supported on the FTB-810. ITU-T Recommendation G.821 ES, EFS, EC, SES, UAS, ESR, SESR, DM G.826 ES, EFS, EB, SES, BBE, UAS, ESR, SESR, BBER G.828 ES, EFS, EB, SES, BBE, UAS, ESR, SESR, BBER G.829 ES, EFS, EB, SES, BBE, UAS, ESR, SESR, BBER M.2100 ES, SES, UAS, ESR, SESR, BBER M.2101 ES, SES, BBE, UAS, ESR, SESR, BBER						
Pointer adjustment and analysis	Generation and analysis of HO/AU and LO/TU pointer adjustments as per GR-253, and ITU-T G.707 Generation Analysis > Pointer increment and decrement > Pointer increments > Pointer jump with or without NDF > Pointer decrements > Pointer value > Pointer value and cumulative offset						
Service disruption time (SDT) measurements	The service disruption time test tool measures the time during which there is a disruption of service due to the network switching from the active channels to the backup channels. Measurements: last disruption, shortest disruption, longest disruption, average disruption, total disruption, and service disruption count.						
Round-trip delay (RTD) measurements	The round-trip delay test tool measures the time required for a bit to travel from the FTB-810 transmitter back to its receiver after crossing a far-end loopback. Measurements are provided on all supported FTB-810 interfaces and mappings. Measurements: last, minimum, maximum, average; measurement count: no. of successful RTD tests and failed measurement count.						
APS message control and monitoring	Ability to monitor and set up automatic protection switching messages (K1/K2 byte of SONET/SDH overhead).						
Synchronization status	Ability to monitor and set up synchronization status messages (S1 byte of SONET/SDH overhead).						
Signal label control and monitoring	Ability to monitor and set up payload signal labels (C2, V5 byte of SONET overhead).						
Tandem connection monitoring (TCM) ^a	Tandem connection monitoring (TCM), is used to monitor the performance of a subsection of a SONET/SDH path routed via different network providers. The FTB-810 supports transmitting and receiving alarms and errors on a TCM link; also, transmission and monitoring of the tandem connection (TC) trace can be generated to verify the connection between TCM equipment. Error generation: TC-IEC, TC-BIP, TC-REI, TC-OEI, TC-VIOL (non-standardized alarm) Alarm generation: TC-RDI, TC-UNEQ, TC-ODI, TC-LTC, TC-IAIS Alarm analysis: TC-TIM, TC-RDI, TC-UNEQ, TC-ODI, TC-LTC, TC-IAIS						
Pointer sequence testing	Perform pointer sequence testing as per G.783, GR253 and T1.105-3 standards.						
M13 mux/demux	Ability to multiplex/demultiplex a DS1 signal into/from a DS3 signal. (Note: E1 to DS3 mux/demux available with G.747 software option.)						
DS1 FDL	Support for DS1 Facility Data Link testing.						
DS1 loopcodes	Support for generation of DS1 in-band loopcodes with the availability of up to 10 pairs of user-defined loopcodes.						
NI/CSU loopback emulation	Ability to respond to DS1 in-band/out-of-band loopcodes.						
DS3 FEAC	Support for DS3 far-end alarms and loopback code words.						
DS1/DS3 auto detection	Ability to automatically detect DS1/DS3 line coding, framing and test pattern.						
Through mode	Perform Through mode analysis of any incoming electrical (DSn, PDH, SONET, SDH) and optical line (OC-3/STM-1, OC-12/STM-4, OC-48/STM-16, OC-192/STM-64) transparently						

Notes

a. HOP and LOP supported as per ITU G.707 option 2.

ADDITIONAL FEATURES					
Power measurement	Supports power measurement at all times, displayed in dBm (dBdsx for DS1 and DS3), for optical and electrical interfaces.				
Power-up and restore	In the event of a power failure to the unit, the active test configuration and test logger are saved and restored upon boot-up.				
Save and load configuration	configuration Store and load test configurations to/from a non-volatile USB memory stick or internal flash.				
Pass/fail analysis	Provides a pass/fail outcome with user-adjustable thresholds, based on bit error rate and/or service disruption time.				
Alarm hierarchy	Alarms are displayed according to a hierarchy based on root cause. Secondary effects are not displayed. This hierarchy serves to facilitate alarm analysis.				
Report generation Generate test reports on the unit or exported via USB.					
Event logger Log test results with absolute or relative time and date, details and duration of events, color-coded events and pass/fail outcome.					
Remote control	Remote control through VNC.				

UPGRADES		
SFP upgrades	FTB-8190	SFP module; rates: 155/622 Mbit/s, 2.5/2.7 Gbit/s, GigE/FC/2FC; 1310 nm, LC connector, 15 km reach
	FTB-8191	SFP module; rates: 155/622 Mbit/s, 2.5/2.7 Gbit/s, GigE/FC/2FC; 1310 nm, LC connector, 40 km reach
	FTB-8192	SFP module; rates: 155/622 Mbit/s, 2.5/2.7 Gbit/s, GigE/FC/2FC; 1550 nm, LC connector, 80 km reach
	FTB-8193	SFP module; rates: 155/622 Mbit/s, 2.5/2.7 Gbit/s, GigE/FC/2FC; 1550 nm, LC connector, 40 km reach
	FTB-8194	SFP module; rates: 155/622 Mbit/s; 1310 nm, LC connector, 15 km reach
	FTB-8195	SFP module; rates: 155/622 Mbit/s; 1310 nm, LC connector, 40 km reach
	FTB-8196	SFP module; rates: 155/622 Mbit/s; 1550 nm, LC connector, 80 km reach
SFP+ upgrades	FTB-8693	SFP+ modules, 9.953-10.709/11.3, 1310 nm, SMF, 10 km
	FTB-8694	SFP+ modules, 8.5 9.953-10.709/11.1, 1550 nm, SMF, 40 km
	FTB-8695	SFP+ modules, 8.5 9.953-10.709/11.1, 1550 nm, SMF, 80 km

GENERAL SPECIFICATIO	GENERAL SPECIFICATIONS				
Size (H x W x D)	130 mm x 252 mm x 56 mm (5 1/8 in x 9 15/16 in x 2 3/16 in)				
Weight (without battery)	vithout battery) 0.97 kg (2.1 lb)				
Temperature Operating Storage	0 °C to 50 °C (32 °F to 122 °F) -40 °C to 70 °C (-40 °F to 158 °F)				
Relative humidity	0 % to 93 %, non-condensing				
Battery life (typical usage)	Over 4 hours				
Battery charging time 2 hours from full discharge to full charge					
Languages	English, Chinese				

ORDERING INFORMATION

FTB-810-XX-XX-XX

Test options ■

SONET = SONET testing SDH = SDH testing

SONET-SDH = SONET and SDH testing

Rate options ...

155M = 155 Mbit/s (OC-3/STM-1) 622M = 622 Mbit/s (OC-12/STM-4) 2488M = 2.5 Gbit/s (OC-48/STM-16)

Software options ■

00 = Without software options DS3-G747 = G.747 test capability DS1-FDL = DS1 FDL test capability DUAL-RX = DS1/DS3 dual Rx testing DS3-FEAC = DS3 FEAC test capability TCM = Tandem connection monitoring DSn = DSn test capability

PDH = PDH test capability NI-CSU = NI-CSU loopback emulation

Example: FTB-810-SONET-155M-Dual-Rx

FTB-810G-XX-XX-XX

Test options ■ SONET = SONET testing

SDH = SDH testing SONET-SDH = SONET and SDH testing

Rate options

155M = 155 Mbit/s (OC-3/STM-1) 622M = 622 Mbit/s (OC-12/STM-4) 2488M = 2.5 Gbit/s (OC-48/STM-16) 9953M = 10 Gbit/s (OC-192/STM-64)

Software options

00 = Without software options DS3-G747 = G.747 test capability DS1-FDL = DS1 FDL test capability DUAL-RX = DS1/DS3 dual Rx testing DS3-FEAC = DS3 FEAC test capability TCM = Tandem connection monitoring DSn = DSn test capability PDH = PDH test capability NI-CSU = NI-CSU loopback emulation

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EXFO is certified ISO 9001 and attests to the quality of these products. This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation. EXFÓ has made every effort to ensure that the information contained in this specification sheet is accurate. However, we accept no responsibility for any errors or omissions, and we reserve the right to modify design, characteristics and products at any time without obligation. Units of measurement in this document conform to SI standards and practices. In addition, all of EXFO's manufactured products are compliant with the European Union's WEEE directive. For more information, please visit www.EXFO.com/recycle. Contact EXFO for prices and availability or to obtain the phone number of your local EXFO distributor.

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